



OAK SEED

The rich brown shade of Oak Seed brings a warm contrast to any home. It is a matt lacquered, 3-strip oak floor with warm and earthy tones. Darker floors are increasing rapidly in popularity, and we believe it is here to stay.

PRODUCT DETAILS		FACTS		TECHNICAL PROPERTIES		
Article Number	133B14EKHNKW226	Wood Species	Oak	Moisture content	EN13183	7%±2%
EAN Code	7393969048422	Board	3-strip	Minimum Mean Density kg/m³		
Surface treatment	Matt lacquer	Grading	Variation	>500 kg/m³		
Dimensions	2266 x 188 x 13 mm	Range	Kährs Avanti	Reaction To Fire	EN13501-1	Dfl-s1
Weight per Package (kg)	24.55 kg	Collection	Ground Collection	Formaldehyde Emission	EN717-1	E1
Area per Package (m²)	3.41 m²	Resandable	2-3 times	Content PCP	CEN/TR14823	≤ 5 x 10-6n
Area per pallet (m²)	119.35 m²	Natural/Stained	Stained	Breaking Strength N/mm²	EN1533	NPD
Package info	Packages may contain start and stop boards.	Brinell Value	3,7	Thermal Conductivity	EN12664	0,14 W/mK
DETAIL DESCRIPTION		Joint	Woodloc® 5G	Thermal Resistance R-Value	.09 (m2K/W)	
Naturally occuring wood colour variations allowed, from light to dark brown. Sapwood will occur. The product includes small sound and black knots. Knots may vary in size and numbers.		Floor heating	Yes	Biological Durability	EN350-2	Class 1
		Warranty	20 years	CARB2		
		Wear-layer material	Hardwood	Compliant		
		Wear-layer thickness	2.6 mm			
		Core material	Pine/Spruce lamella			
COLOUR CHANGE		LRV	23			
Stained product - noticeable color change over time.		Installation method	Floating, Glue-down			



Descriptions & Imagery

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